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Dated: September 2, 2004

Signature:

*Richard H. Anderson*  
(Richard H. Anderson)

Docket No.: 27702/10047C-1  
(PATENT)

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Patent Application of:  
Gary Wentworth et al.

Application No.: 10/706,386

Art Unit: 1714

Filed: November 12, 2003

Examiner: Not Yet Assigned

For: LIQUID FORM ESTER/RESIN ADHESION  
PROMOTER

**PRELIMINARY AMENDMENT**

MS Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

**INTRODUCTORY COMMENTS**

Amendment has been made to claims 1, 2, 42 and 46 in view of EP 0 073 174 A1 cited in applicants' latest Information Disclosure Statement. Please amend the above-identified U.S. patent application as follows:

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.

**Remarks/Arguments** begin on page 26 of this paper.